

PARA LIGHT ELECTRONICS CO., LTD.

4F, No.1, Lane 93, Chien Yi Road, Chung Ho City, Taipei, Taiwan, R.O.C.Tel: 886-2-2225-3733Fax: 886-2-2225-4800E-mail: para@para.com.twhttp://www.para.com.tw

DATA SHEET

PART NO.: L-S020GRBCT-HH

REV: <u>A/3</u>

CUSTOMER'S APPROVAL : _____

DCC :

DRAWING NO.: DS-7A-16-0010

DATE : 2016-10-11

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• Chip Materials

- * Dice Material : GaAlInP/GaInN
- * Light Color : Red / Green/Blue
- * Lens Color : Water clear

• Absolute Maximum Ratings(Ta= 25° C)

SYMBOL	DESCRIPTION	RED	GREEN	BLUE	UNIT
PD	Power Dissipation	72	108	108	mW
VR	Reverse Voltage(Min)	5	5	5	V
IR	Reverse Current (VR=5V) (Max)	100	100	100	μA
IPF	Peak Forward Current (Duty=0.1,1KHZ)	30	30	30	mA
-	Derating Linear From 25°C	0.4	0.4	0.4	mA/°C
Topr	Operating Temperature Range	-30°C to 80°C			
Tstg	Storage Temperature Range	-20°C to 85°C			

Electro-Optical Characteristics (Ta=25°C)

SYMBOL	PARAMETER	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
VF	Forward Voltage	IF=20mA	RED		2.0	2.6	V
			GREEN		3.0	3.6	V
			BLUE		3.0	3.6	V
λD	Dominant Wavelength	IF=20mA	RED		622	625	nm
			GREEN		520	525	nm
			BLUE		469	475	nm
Δλ	Spectral Line Half-Width	IF=20mA	RED		20		nm
			GREEN		38		nm
			BLUE		25		nm
201/2	Half Intensity Angle	IF=20mA	RED				deg
			GREEN		120		
			BLUE				
Iv	Luminous Intensity	IF=20mA	RED	300	600	1000	mcd
			GREEN	900	1300	1800	mcd
			BLUE	300	500	800	mcd

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CAUTIONS

1. Static Electricity:

* Static electricity or surge voltage damages the LEDs.

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

* All devices, equipment and machinery must be properly grounded.

It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

* When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (blew 1mA is recommended).

* Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current. Criteria: (VF>2.0V,at IF=0.5m A)

2. Storage :

* Before opening the package :

The LEDs should be kept at 30°C or less and 85%RH or less. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

* After opening the package :

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture poof bag and to reseal the moisture proof bag again. If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should e performed using the following conditions. Baking treatment: more than 24hours at $65\pm5^{\circ}$ C.

* Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3. Soldering:

Do not apply any stress to the LED lens during soldering while the LED is at high temperature. Recommended soldering condition.

* Reflow Soldering :

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time : 10 sec Max.

* Soldering Iron : (Not recommended)

Temperature350°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

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4. Lead-Free Soldering

For Reflow Soldering :

- 1 $\$ Pre-Heat Temp: 150-180 $^\circ\!\mathrm{C}$,120sec.Max.
- 2 Soldering Temp: Temperature Of Soldering Pot Over 240°C,40sec.Max.
- 3 Seak Temperature: 260°C → 10sec.
- 4 · Reflow Repetition: 2 Times Max.
- 5 Suggest Solder Paste Formula : 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu

For Soldering Iron (Not Recommended) :

- $1 \ \ \$ Iron Tip Temp: 350 $^\circ \ \ \$ Max.
- 2 Soldering Iron: 30w Max.
- 3 Soldering Time: 3 Sec. Max. One Time.
- 5. Drive Method

Circuit model A

Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

- 6. Reliability
 - 1、Criteria For Judging The Damage

ltom	Symbol	Test Conditions	Criteria for Judgement			
nem	Symbol		MIN.	Max.		
Forward Voltage	VF	IF=20mA	-	U.S.L.*)×1.1		
Reverse Current	IR	VR=5V	-	U.S.L.*)×2.0		
Luminous Intensity	IV	IF=20mA	L.S.L**)×0.7	-		

*) U.S.L.: Upper Standard Level

**) L.S.L: Lower Standard Level

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2、Test Items And Results

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
Resitance to Soldering Heat	JEITA ED-4701	Tsld=180°C, 10sec.	2 times	0/20
(Reflow Soldering)	300 301	(Pre treatment 30°C,70%,168hrs)		
Solderability	JEITA ED-4701	Tsld=240±5°C, 3sec.	1time	0/20
(Reflow Soldering)	300 303	(Leader Solder)	over 95%	
Thormal Shools	JEITA ED-4701	-40°C~100°C	100cycles	0/20
Thermal Shock	300 307	5min. 5min.		
Temperature Circle	JEITA ED-4701	-40°C~25°C~100°C~25°C		0/20
Temperature Cycle	100 105	30min. 5min. 30min. 5min.	Toucycles	0/20
Maintana Basistanan Chula	JEITA ED-4701	25°C~65°C~-10°C	101	0/20
Moisture Resistance Cycle	200 203	90%RH 24hrs./1cycle	10 cycles	
High Tanana at an Stars at	JEITA ED-4701	T- 100°C	1000 hrs	0/20
High Temperature Storage	200 201	1a=100 C		
High Temperature	JEITA ED-4701	T- 60% 000/ BII	1000 1	0/20
High Humidity Storage	100 103	1a=00 C, 90%RH		0/20
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40°C	1000 hrs	0/20
Steady State Operating Life		Ta=25°C, IF=20mA	1000 hrs	0/20
Steady State Operating Life of High Temperature		Ta=85°C, IF=20mA	1000 hrs	0/20
Steady State Operating Life of High Humidity Heat		60°C, 90%RH, IF=20mA	500 hrs	0/20
Steady State Operating Life		Ta= 30°C IF=20m 4	1000 hrs	0/20
of Low Temperature		1a50 C, IF-2011A		
Drop		H=75cm	3 cycles	0/20
Substrate Bending	JEITA ED-4702	3mm, 5 ± 1 sec.	1 time	0/20
Stick	JEITA ED-4702	5N, 10 ± 1 sec.	1 time	0/20